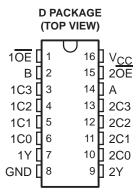
SCLS560 - JANUARY 2004

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of -40°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree[†]
- 3-State Version of 'HC153
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Inverting Outputs Drive Up To 15 LSTTL Loads

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 9 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Permit Multiplexing From n Lines to One Line
- Perform Parallel-to-Serial Conversion



description/ordering information

Each data selector/multiplexer contains inverters and drivers to supply full binary decoding data selection to the AND-OR gates. Separate output-control inputs are provided for each of the two 4-line sections.

The 3-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (in the high-impedance state), the low impedance of the single enabled output drives the bus line to a high or low logic level. Each output has its own output-enable (\overline{OE}) input. The outputs are disabled when their respective \overline{OE} is high.

ORDERING INFORMATION

TA	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	SOIC – D Tape and r		SN74HC253QDREP	SHC253QEP

[‡] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design quidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



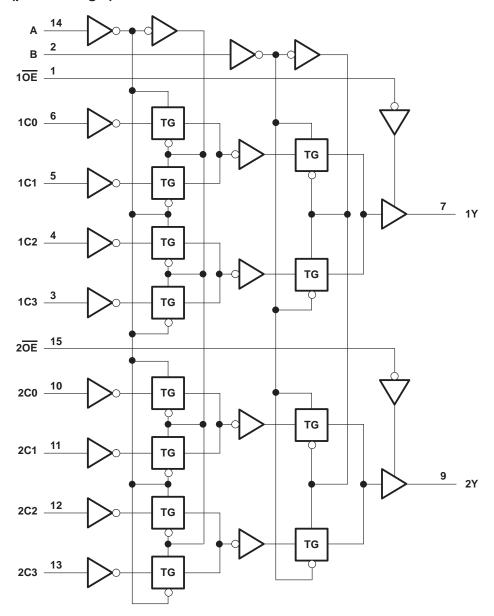
SN74HC253-EP DUAL 4-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS SCLS560 - JANUARY 2004

FUNCTION TABLE

			INPUTS				
SELE	ЕСТ†		DA	TA		ŌĒ	OUTPUT
В	Α	C0	C1	C2	C3	OE	·
Х	Χ	Х	Χ	Χ	Χ	Н	Z
L	L	L	Χ	Χ	Χ	L	L
L	L	Н	Χ	Χ	Χ	L	Н
L	Н	Χ	L	Χ	Χ	L	L
L	Н	Χ	Н	Χ	Χ	L	Н
Н	L	Χ	Χ	L	Χ	L	L
Н	L	Χ	Χ	Н	X	L	Н
Н	Н	Х	Χ	Χ	L	L	L
Н	Н	Χ	Χ	Χ	Н	L	Н

[†] Select inputs A and B are common to both sections.

logic diagram (positive logic)





SN74HC253-EP DUAL 4-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS

SCLS560 - JANUARY 2004

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	0.5	\mbox{V} to 7 \mbox{V}
Input clamp current, $I_{ K }(V_1 < 0 \text{ or } V_1 > V_{CC})$ (see Note 1)		±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1)		$\pm 20~\text{mA}$
Continuous output current, I_O ($V_O = 0$ to V_{CC})		$\pm 25~\text{mA}$
Continuous current through V _{CC} or GND		$\pm 50~\text{mA}$
Package thermal impedance, θ_{JA} (see Note 2)		73°C/W
Storage temperature range, T _{stq}	-65°C t	to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2	5	6	V
		V _{CC} = 2 V	1.5			
V_{IH}	High-level input voltage	V _{CC} = 4.5 V	3.15			V
		VCC = 6 V	4.2			
		V _{CC} = 2 V			0.5	
\vee_{IL}	Low-level input voltage	V _{CC} = 4.5 V			1.35	V
		V _{CC} = 6 V			1.8	
V_{I}	Input voltage		0		V_{CC}	V
VO	Output voltage		0		VCC	V
		V _{CC} = 2 V			1000	
$\Delta t/\Delta v$	Input transition rise/fall time	$V_{CC} = 4.5 \text{ V}$			500	ns
		VCC = 6 V			400	
TA	Operating free-air temperature		-40		125	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

SN74HC253-EP DUAL 4-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS SCLS560 – JANUARY 2004

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIO		Т	A = 25°C	;		BA A V	LINUT	
PARAMETER	TEST CONDITION	DNS	vcc	MIN	TYP	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		
	VI = VIH or VIL	$I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		
Voн			6 V	5.9	5.999		5.9		V
		$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		
		$I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2		
			2 V		0.002	0.1		0.1	
		$I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1	
VoL	VI = VIH or VIL		6 V		0.001	0.1		0.1	V
		I _{OL} = 6 mA	4.5 V		0.17	0.26		0.4	
		$I_{OL} = 7.8 \text{ mA}$	6 V		0.15	0.26		0.4	
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100	:	±1000	nA
loz	VO = VCC or 0		6 V		±0.01	±0.5		±10	μΑ
Icc	$V_I = V_{CC}$ or 0,	IO = 0	6 V			8		160	μΑ
C _i			2 V to 6 V		3	10		10	pF

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	.,	TΔ	(= 25°C	;	BAIN! BAAY	
PARAMETER	(INPUT)	(OUTPUT)	vcc	MIN	TYP	MAX	MIN MAX	UNIT
			2 V		62	150	225	
	A or B	Any Y	4.5 V		19	30	45	
	Data (Any C)		6 V		16	26	38	
^t pd			2 V		54	126	210	ns
		Υ	4.5 V		16	28	42	
			6 V		13	23	36	
			2 V		28	100	150)
^t en	ŌĒ	Y	4.5 V		11	20	30	ns
			6 V		9	17	26	
			2 V		21	135	203	
^t dis	ŌĒ	Y	4.5 V		14	30	45	ns
			6 V		12	35	38	
			2 V		28	60	90	
t _t		Υ	4.5 V		8	12	18	ns
			6 V		6	10	15	

SN74HC253-EP DUAL 4-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER WITH 3-STATE OUTPUTS SCLS560 - JANUARY 2004

switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	.,	T,	Վ = 25° C	;	BAIN! BAIN	
PARAMETER	(INPUT)	(OUTPUT)	vcc	MIN	TYP	MAX	MIN MAX	UNIT
			2 V		76	235	355	
	A or B	Any Y	4.5 V		23	47	71	
	Data (Any C)		6 V		20	41	60	
^t pd			2 V		68	220	335	ns
		Υ	4.5 V		20	44	67	
	(Ally O)		6 V		17	38	57	
			2 V		44	185	280	
^t en	ŌĒ	Y	4.5 V		16	37	56	ns
			6 V		14	32	48	
			2 V		45	210	315	
t _t		Υ	4.5 V		17	42	63	ns
			6 V		13	36	53	

operating characteristics, $T_A = 25^{\circ}C$

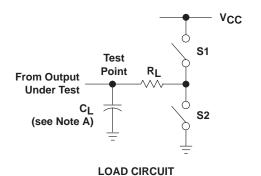
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per multiplexer	No load	45	pF

Rı

PARAMETER

S2

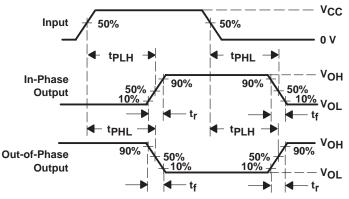
PARAMETER MEASUREMENT INFORMATION



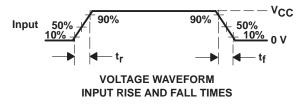
50 pF **tPZH** Open Closed 1 $k\Omega$ or ten **tPZL** Closed 150 pF Open ^tPHZ Open Closed 50 pF $1 k\Omega$ tdis **tPLZ** Closed Open 50 pF Open tpd or tt Open or 150 pF

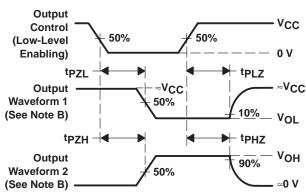
Cı

S1



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES





VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

- NOTES: A. C_L includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74HC253QDREP	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SHC253QEP	Samples
V62/04699-01XE	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	SHC253QEP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

OTHER QUALIFIED VERSIONS OF SN74HC253-EP:

Catalog: SN74HC253

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Automotive: SN74HC253-Q1

• Military: SN54HC253

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Aug-2021

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

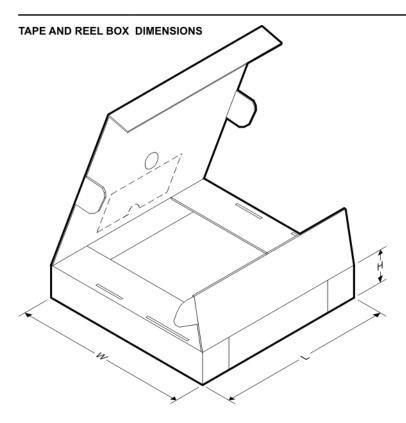
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC253QDREP	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

www.ti.com 3-Aug-2021



*All dimensions are nominal

I	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	SN74HC253QDREP	SOIC	D	16	2500	340.5	336.1	32.0

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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